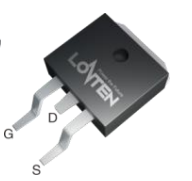
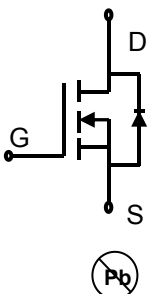


Lonten N-channel 100V, 180A, 3.5mΩ Power MOSFET

Description These N-Channel enhancement mode power field effect transistors are using split gate trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications. Features ◆ 100V,180A, $R_{DS(on),max}=3.5m\Omega@V_{GS}=10V$ ◆ Improved dv/dt capability ◆ Fast switching ◆ 100% EAS Guaranteed ◆ Green device available Applications ◆ Motor Drives ◆ UPS ◆ DC-DC Converter	Product Summary <table> <tr> <td>V_{DSS}</td><td>100V</td></tr> <tr> <td>$R_{DS(on),max}@V_{GS}=10V$</td><td>3.5mΩ</td></tr> <tr> <td>I_D</td><td>180A</td></tr> </table> Pin Configuration  TO-220  TO-220MF  TO-263  N-Channel MOSFET	V_{DSS}	100V	$R_{DS(on),max}@V_{GS}=10V$	3.5mΩ	I_D	180A
V_{DSS}	100V						
$R_{DS(on),max}@V_{GS}=10V$	3.5mΩ						
I_D	180A						

Absolute Maximum Ratings $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	100	V
Continuous drain current ($T_C = 25^\circ C$) ¹⁾	I_D	180	A
Continuous drain current ($T_C = 100^\circ C$) ¹⁾		117	A
Pulsed drain current ²⁾	I_{DM}	540	A
Gate-Source voltage	V_{GSS}	± 20	V
Avalanche energy ³⁾	E_{AS}	306	mJ
Power Dissipation ($T_C = 25^\circ C$)	P_D	181	W
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.55	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	$^\circ C/W$

Package Marking and Ordering Information

Device	Device Package	Marking
LSGC10R035	TO-220	LSGC10R035
LSGD10R035	TO-220MF	LSGD10R035
LSGE10R035	TO-263	LSGE10R035

Electrical Characteristics
 $T_J = 25^{\circ}\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	100	---	---	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2.0	3.0	4.0	V
Drain-source leakage current	I _{DSS}	V _{DS} =100 V, V _{GS} =0V, T _J = 25°C	---	---	1	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V	---	---	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V	---	---	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =50 A	---	3.0	3.5	mΩ
Forward transconductance	g _{fs}	V _{DS} =10V , I _D =20A	---	85	---	S
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 50 V, V _{GS} = 0 V, F = 1MHz	---	9430	---	pF
Output capacitance	C _{oss}		---	882	---	
Reverse transfer capacitance	C _{rss}		---	48	---	
Turn-on delay time	t _{d(on)}	V _{DD} = 50V,V _{GS} =10V, I _D = 20A	---	48	---	ns
Rise time	t _r		---	70	---	
Turn-off delay time	t _{d(off)}		---	235	---	
Fall time	t _f		---	66	---	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	2.6	---	Ω
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DS} =50 V, I _D =20A, V _{GS} = 10 V	---	39	---	nC
Gate to drain charge	Q _{gd}		---	33	---	
Gate charge tota	Q _g		---	123	---	
Drain-Source diode characteristics and Maximum Ratings						
Continuous Source Current	I _S		---	---	180	A
Pulsed Source Current ⁴⁾	I _{SM}		---	---	540	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =50A, T _J =25°C	---	0.85	1.3	V
Reverse Recovery Time	t _{rr}	I _S =20A, di/dt=100A/us,	---	82	---	ns
Reverse Recovery Charge	Q _{rr}	T _J =25°C	---	213	---	nC

Notes:

- 1: The maximum junction current rating is package limited.
- 2: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3: $V_{DD}=50\text{ V}, V_{GS}=10\text{ V}, L=0.5\text{ mH}, I_{AS}=35\text{ A}, R_G=25\Omega$, Starting $T_J=25^{\circ}\text{C}$.
- 4: Pulse Test: Pulse Width $\leq 300\mu\text{ s}$, Duty Cycle $\leq 2\%$.

Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

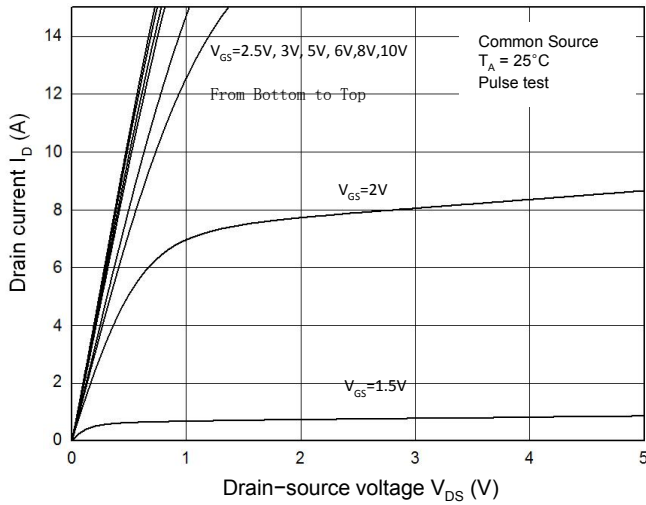


Figure 2. Transfer Characteristics

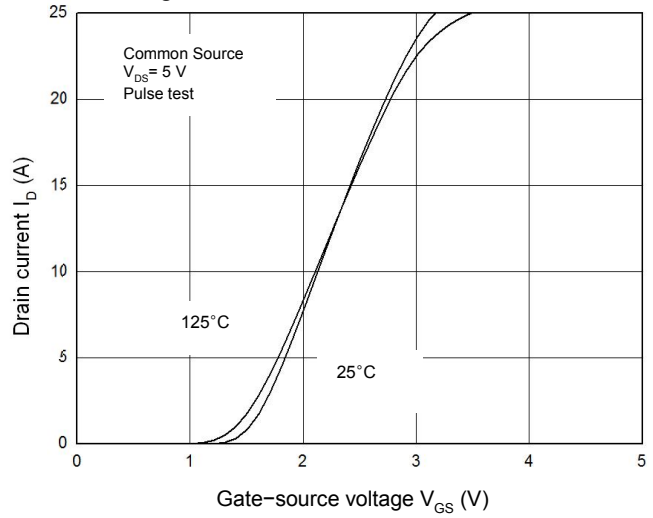


Figure 3. Capacitance Characteristics

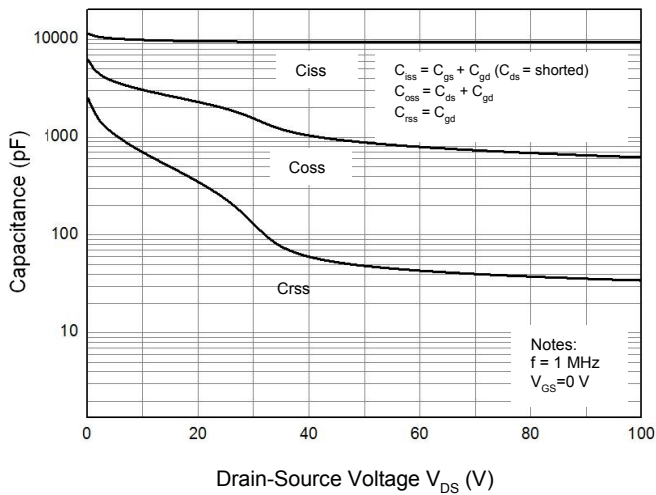


Figure 4. Gate Charge Waveform

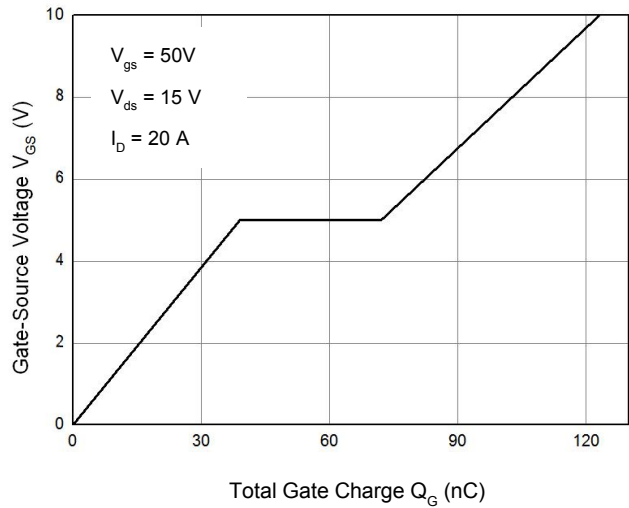


Figure 5. Body-Diode Characteristics

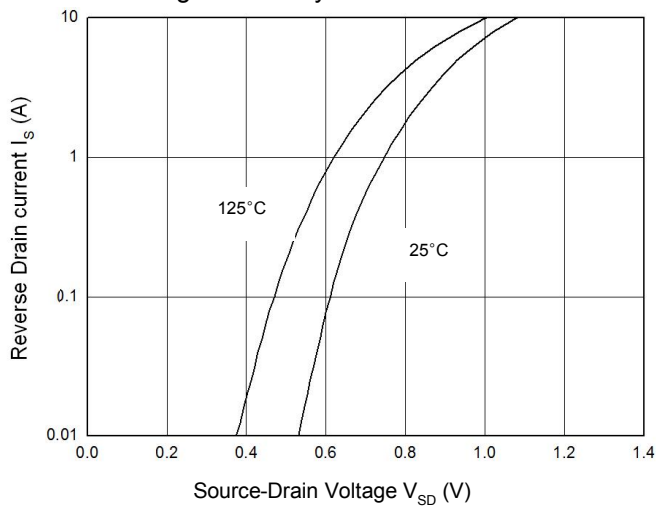


Figure 6. Rdson-Drain Current

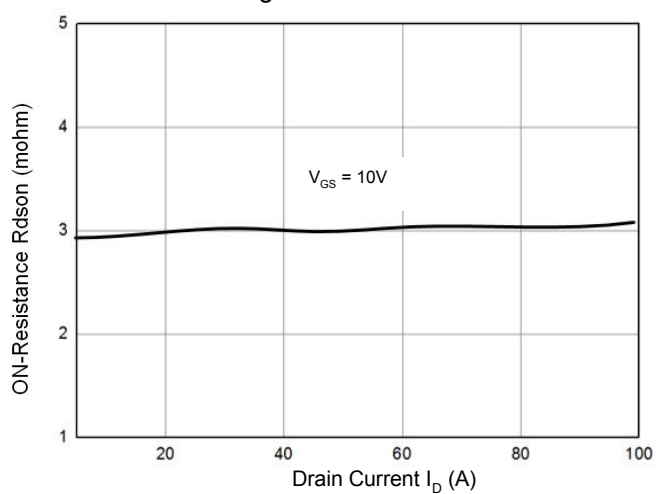
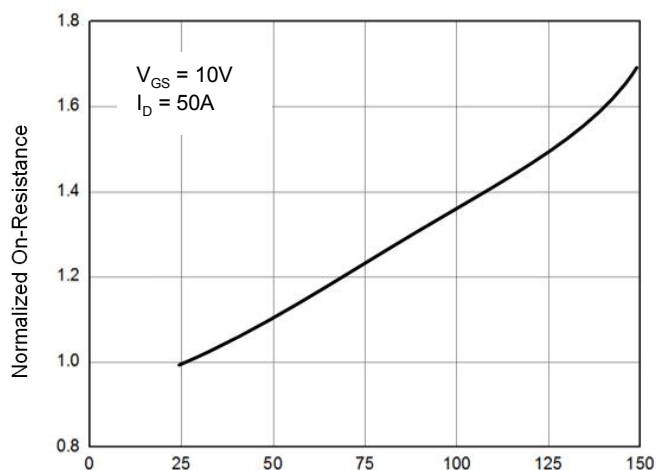


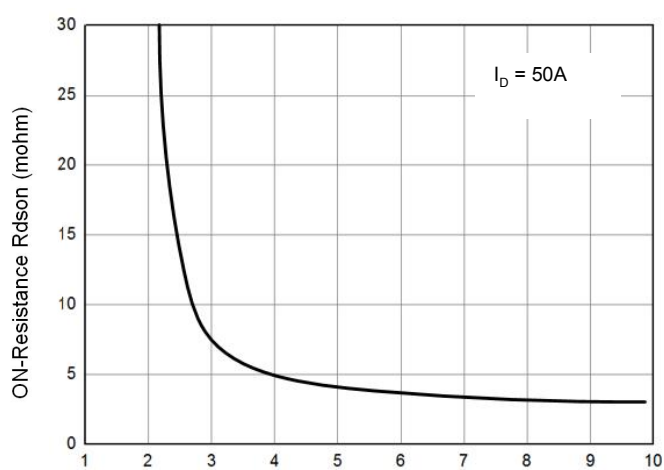
Figure 7. $R_{DS(on)}$ -Junction Temperature($^{\circ}\text{C}$)



T_J -Junction Temperature ($^{\circ}\text{C}$)

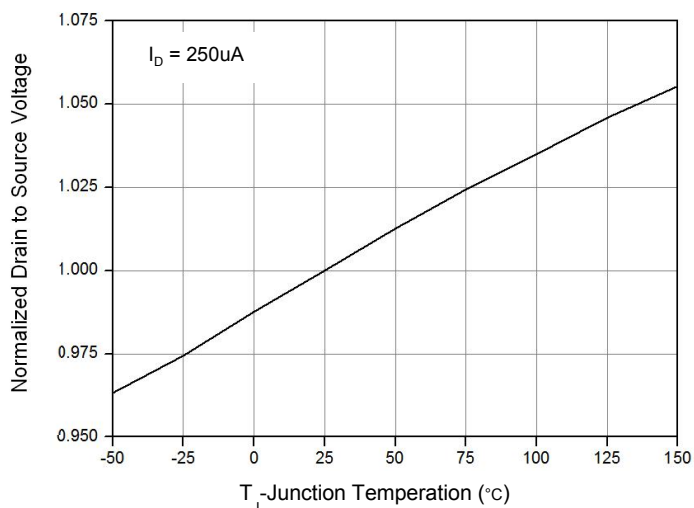
Figure 9. BV_{DS} vs. Junction temperature($^{\circ}\text{C}$)

Figure 8. $R_{DS(on)}$ vs Gate Voltage



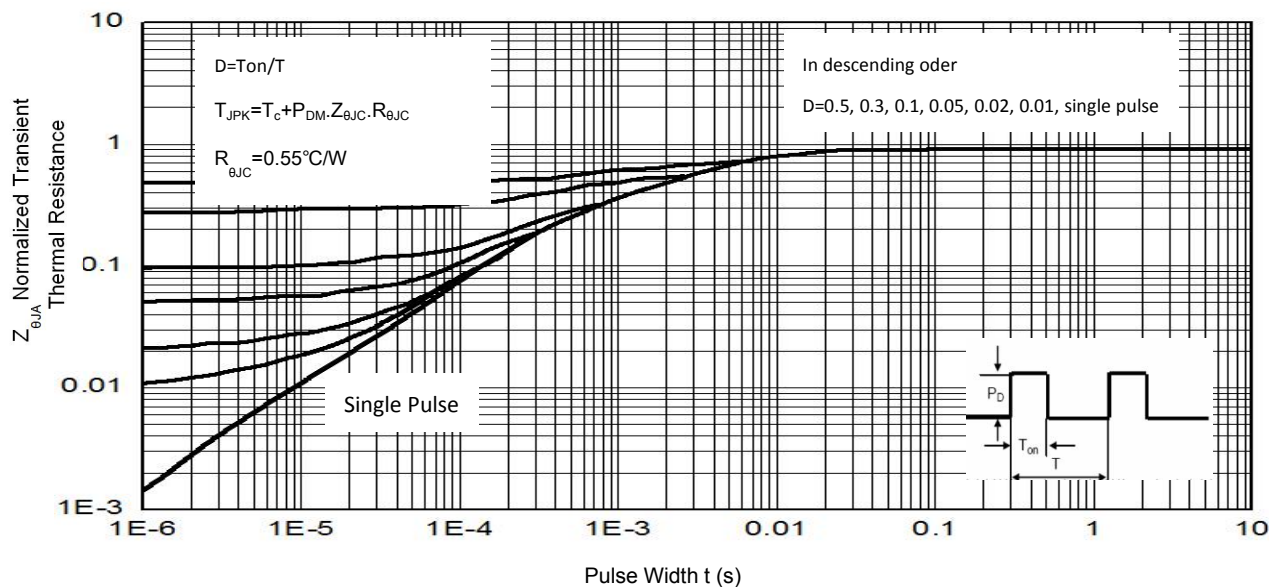
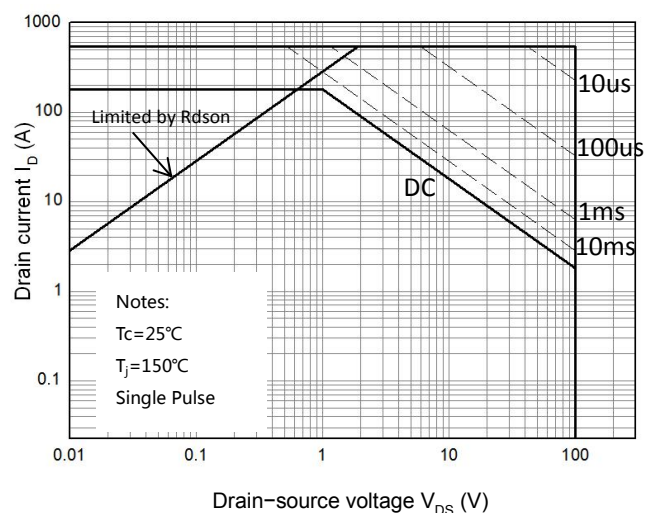
Gate-source voltage V_{GS} (V)

Figure 10. Maximum Safe Operating Area



T_J -Junction Temperature ($^{\circ}\text{C}$)

Figure 9. Normalized Maximum Transient Thermal Impedance (R_{thJA})



Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform

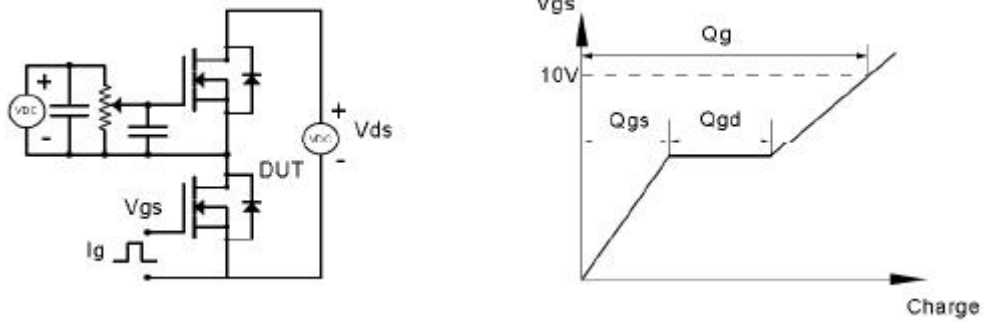


Figure 9. Resistive Switching Test Circuit & Waveforms

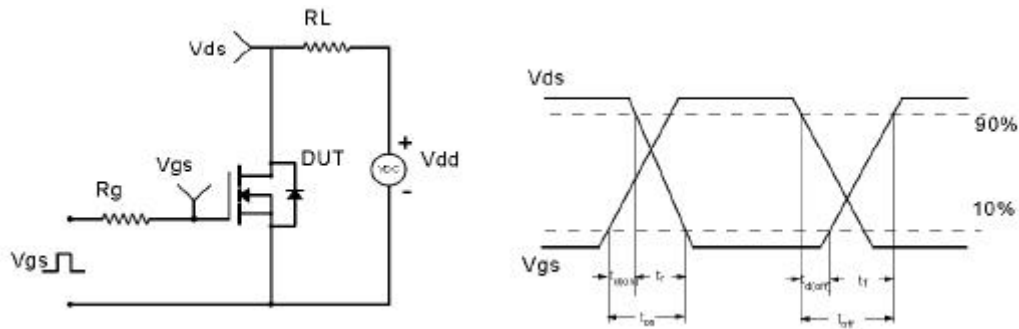


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

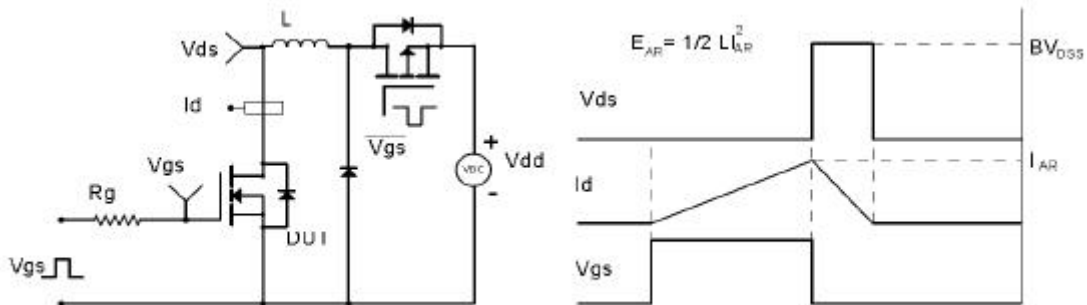
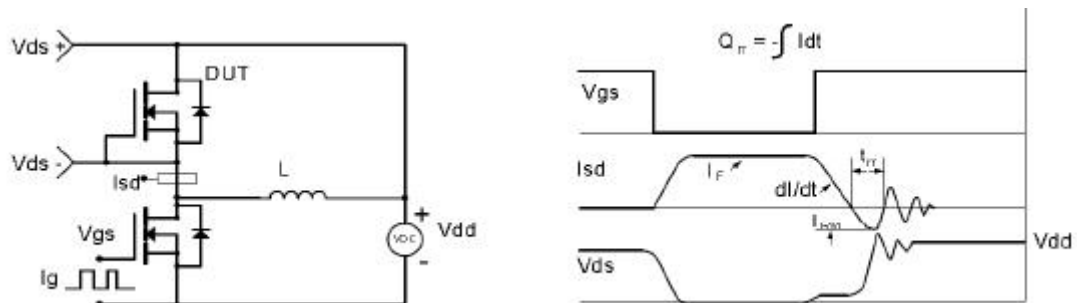
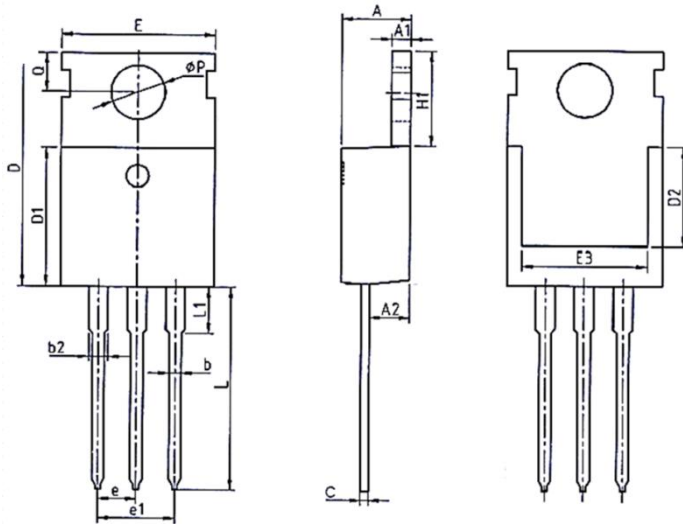


Figure 11. Diode Recovery Circuit & Waveform

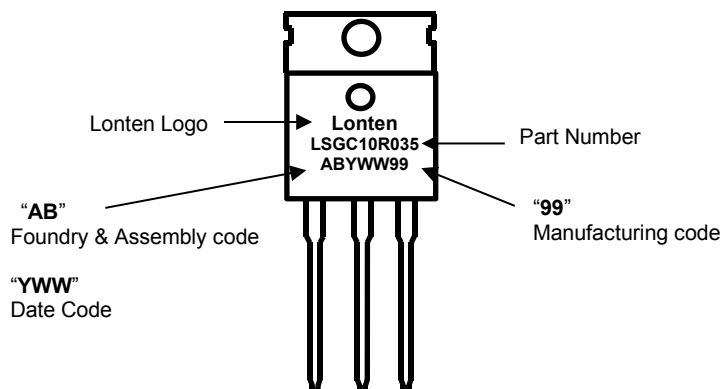


Mechanical Dimensions for TO-220

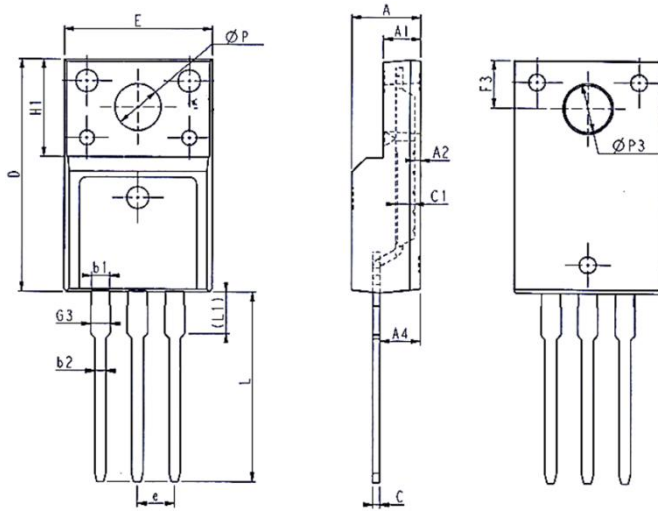


SYMBOL	COMMON DIMENSIONS					
	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.37	4.57	4.70	0.172	0.180	0.185
A1	1.25	1.30	1.40	0.049	0.051	0.055
A2	2.20	2.40	2.60	0.087	0.094	0.102
b	0.70	0.80	0.95	0.028	0.031	0.037
b2	1.17	1.27	1.47	0.046	0.050	0.058
c	0.45	0.50	0.60	0.018	0.020	0.024
D	15.10	15.60	16.10	0.594	0.614	0.634
D1	8.80	9.10	9.40	0.346	0.358	0.370
D2	5.50	-	-	0.217	-	-
E	9.70	10.00	10.30	0.382	0.394	0.406
E3	7.00	-	-	0.276	-	-
e	2.54BCS			0.1BSC		
e1	5.08BCS			0.2REF		
H1	6.25	6.50	6.85	0.246	0.256	0.270
L	12.75	13.50	13.80	0.502	0.531	0.543
L1	-	3.10	3.40	-	0.122	0.134
ØP	3.40	3.60	3.80	0.134	0.142	0.150
Q	2.60	2.80	3.00	0.102	0.110	0.118

TO-220 Part Marking Information

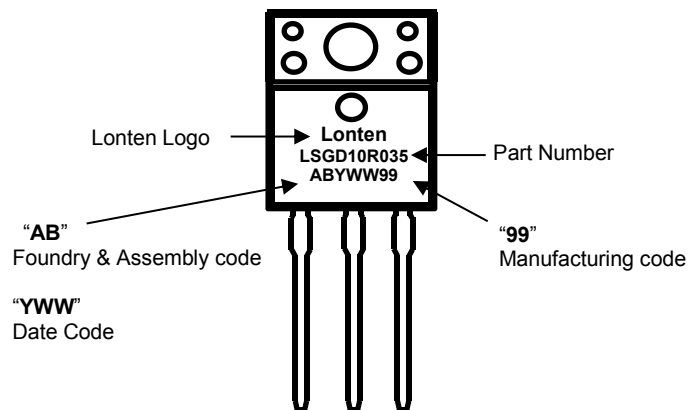


Mechanical Dimensions for TO-220MF

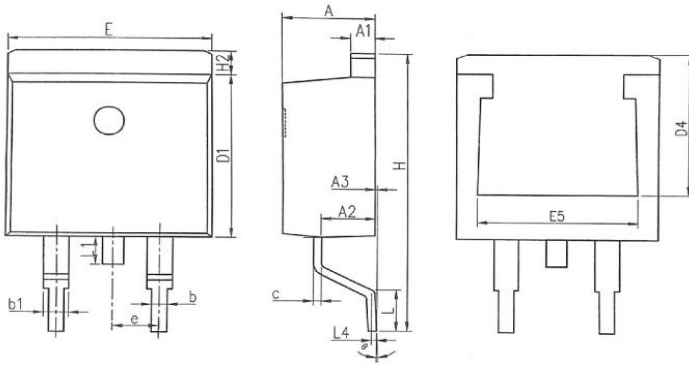


SYMBOL	COMMON DIMENSIONS					
	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
E	9.96	10.16	10.36	0.392	0.400	0.408
A	4.50	4.70	4.90	0.177	0.185	0.193
A1	2.34	2.54	2.74	0.092	0.100	0.108
A2	0.30	0.45	0.60	0.012	0.018	0.024
A4	2.56	2.76	2.96	0.101	0.109	0.117
c	0.40	0.50	0.65	0.016	0.020	0.026
c1	1.20	1.30	1.35	0.047	0.051	0.053
D	15.57	15.87	16.17	0.613	0.625	0.637
H1	6.70REF			0.264REF		
e	2.54BSC			0.1BSC		
L	12.68	12.98	13.28	0.499	0.511	0.523
L1	2.88	3.03	3.18	0.113	0.119	0.125
ØP	3.03	3.18	3.38	0.119	0.125	0.133
ØP3	3.15	3.45	3.65	0.124	0.136	0.144
F3	3.15	3.30	3.45	0.124	0.130	0.136
G3	1.25	1.35	1.55	0.049	0.053	0.061
b1	1.18	1.28	1.43	0.046	0.050	0.056
b2	0.70	0.80	0.95	0.028	0.031	0.037

TO-220MF Part Marking Information

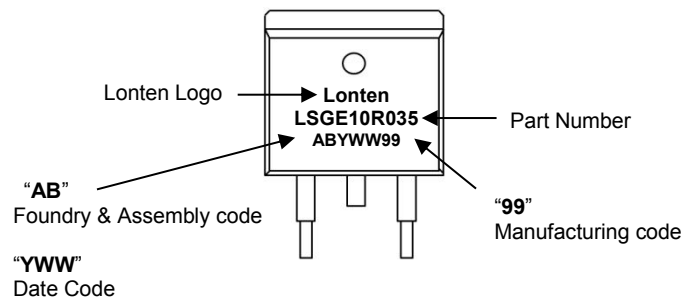


TO-263 PACKAGE INFORMATION



COMMON DIMENSIONS						
SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.37	4.57	4.77	0.172	0.180	0.188
A1	1.22	1.27	1.42	0.048	0.050	0.056
A2	2.49	2.69	2.89	0.098	0.106	0.114
A3	0.00	0.13	0.25	0.000	0.005	0.010
b	0.70	0.81	0.96	0.028	0.032	0.038
b1	1.17	1.27	1.47	0.046	0.050	0.058
c	0.30	0.38	0.53	0.012	0.015	0.021
D1	8.50	8.70	8.90	0.335	0.343	0.350
D4	6.60	—	—	0.260	—	—
E	9.86	10.16	10.36	0.388	0.400	0.408
E5	7.06	—	—	0.278	—	—
e	2.54 BSC			0.100 BSC		
H	14.70	15.10	15.50	0.579	0.594	0.610
H2	1.07	1.27	1.47	0.042	0.050	0.058
L	2.00	2.30	2.60	0.079	0.091	0.102
L1	1.40	1.55	1.70	0.055	0.061	0.067
L4	0.25 BSC			0.010 BSC		
θ	0°	5°	9°	0°	5°	9°

TO-263 Part Marking Information



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